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	Subclass	ISSUE CLASSIFICATION
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PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E.

PATENT DATE

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APPLICATION NO. 09/602951	CONT/PRIOR D	CLASS 029	SUBCLASS 2	3729	Chang

Belgacem Haba

Method for forming a multi-layer circuit assembly

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	CROSS REFERENCE(S)
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